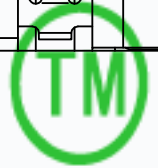
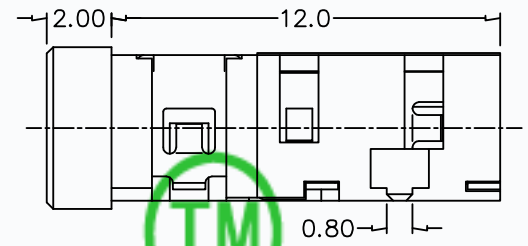
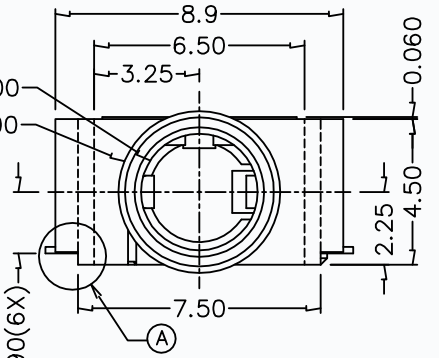
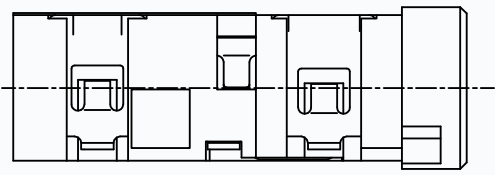
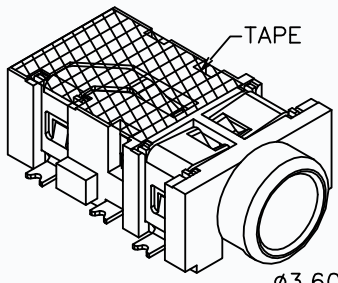
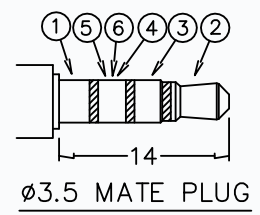
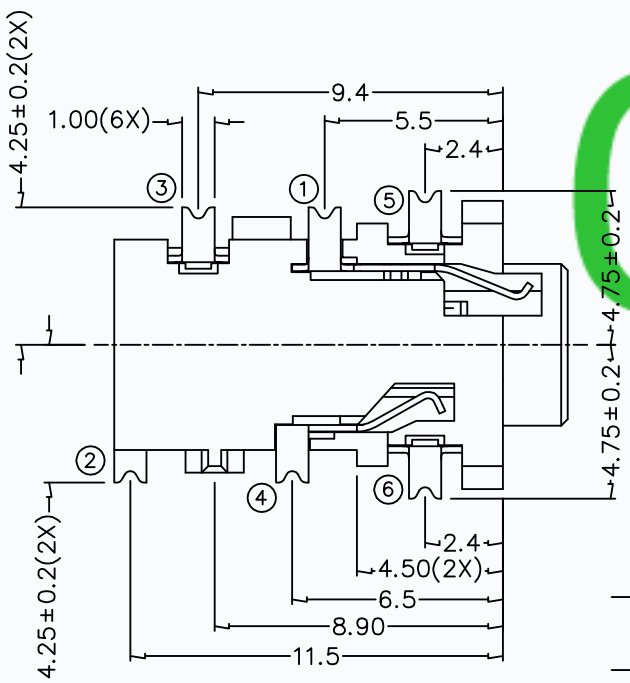


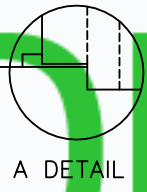
CAD FILE:



CMTDDZ

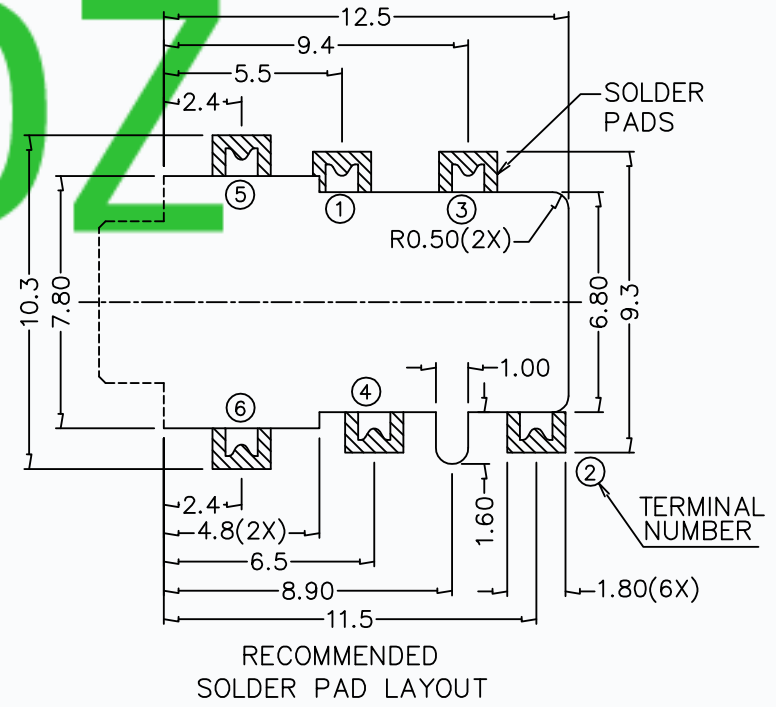
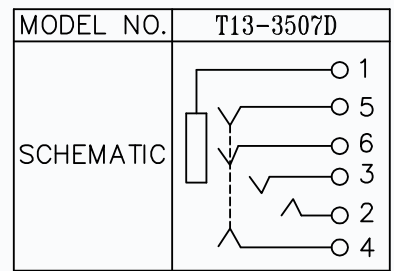


COPLANARITY 0.1



*** MATERIAL**

- TERMINAL 1 : COPPER ALLOY
- TERMINAL 2 : COPPER ALLOY
- TERMINAL 3 : COPPER ALLOY
- TERMINAL 4 : COPPER ALLOY
- TERMINAL 5 : COPPER ALLOY
- TERMINAL 6 : COPPER ALLOY
- HOUSING : PA6T
- TAPE : POLYIMIDE



APPD.	DESCRIPTIONS OF REVISION

TOLERANCE UNLESS SPECIFIED
 WITHIN 1.5mm : ±0.1mm
 OVER 1.5mm : ±0.2mm

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TITLE : 3.5mm SMD PHONE JACK
MODEL: T13-3507D
CMTDDZ 东莞市田都电子有限公司
 DONGGUAN TIANDU ELECTRONICS CO.,LTD.

UNIT : mm	DRWG NO.: CMTDDZ-T13-3507D-00
SCALE: 3:1	DWN. ERIC 2013-6-17
APPD. Coco	CHK'D MAIKO 2013-6-17
	APPD. Coco 2013-6-17